

SC 1/20



		Subclass	
	Class		<b>ISSUE CLASSIFICATION</b>

**PATENT NUMBER**

**U.S. UTILITY** Patent Application

O.I.P.E.

**PATENT DATE**

JK SCANNED 583/2 <sup>N</sup> on CII

APPLICATION NO. 09/901416	CONT/PRIOR	CLASS 438	SUBCLASS	ART UNIT 2812 2813	EXAMINER
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## APPlicants

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TITLE

Dual hardmask interconnects Process for the formation of copper/low-k

PTO-2040  
12/89

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## **ISSUING CLASSIFICATION**

Continued on Issue Slip Inside File Jacket

TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
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<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____	(Assistant Examiner) _____  (Date)				
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	(Primary Examiner) _____  (Date)			ISSUE FEE	
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